

## Aluminum Electrolytic Capacitors SMD (Chip), High Voltage

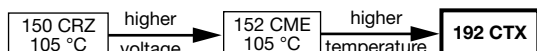


Fig. 1

### QUICK REFERENCE DATA

DESCRIPTION	VALUE
Nominal case sizes (L x W x H in mm)	10 x 10 x 10 to 18 x 18 x 21
Rated capacitance range, $C_R$	2.2 $\mu$ F to 33 $\mu$ F
Tolerance on $C_R$	$\pm 20 \%$
Rated voltage range, $U_R$	400 V
Category temperature range	-40 °C to +125 °C
Endurance test at 125 °C	1000 h to 2000 h
Useful life at 125 °C	1000 h to 2500 h
Useful life at 40 °C 1.8 x $I_R$ applied	75 000 h to 150 000 h
Shelf life at 0 V, 125 °C	1000 h
Based on sectional specification	IEC 60384-18 / CECC 32300
Climatic category IEC 60068	40 / 125 / 56

### FEATURES

- Extended useful life: up to 2500 h at 125 °C
- Polarized aluminum electrolytic capacitors, non-solid electrolyte, self healing
- SMD-version with base plate, lead (Pb)-free reflow solderable
- Charge and discharge proof, no peak current limitation
- Advanced temperature reflow soldering according to JEDEC® J-STD-020
- Vibration proof, 4-pin version and 6-pin version
- AEC-Q200 qualified
- High reliability
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### APPLICATIONS

- SMD technology, for high temperature reflow soldering
- Industrial and professional applications
- Automotive, general industrial, telecom
- Smoothing, filtering, buffering

### MARKING

- Rated capacitance (in  $\mu$ F)
- Rated voltage (in V)
- Date code, in accordance with IEC 60062
- Black mark or “-” sign indicating the cathode (the anode is identified by beveled edges)
- Code indicating group number (X)

### PACKAGING

Supplied in blister tape on reel

### SELECTION CHART FOR $C_R$ , $U_R$ , AND RELEVANT NOMINAL CASE SIZES (L x W x H in mm)

$C_R$ ( $\mu$ F)	$U_R$ (V)
	400
2.2	10 x 10 x 10
4.7	12.5 x 12.5 x 13
5.6	12.5 x 12.5 x 16
10	16 x 16 x 16
15	16 x 16 x 21
22	18 x 18 x 16
33	18 x 18 x 21

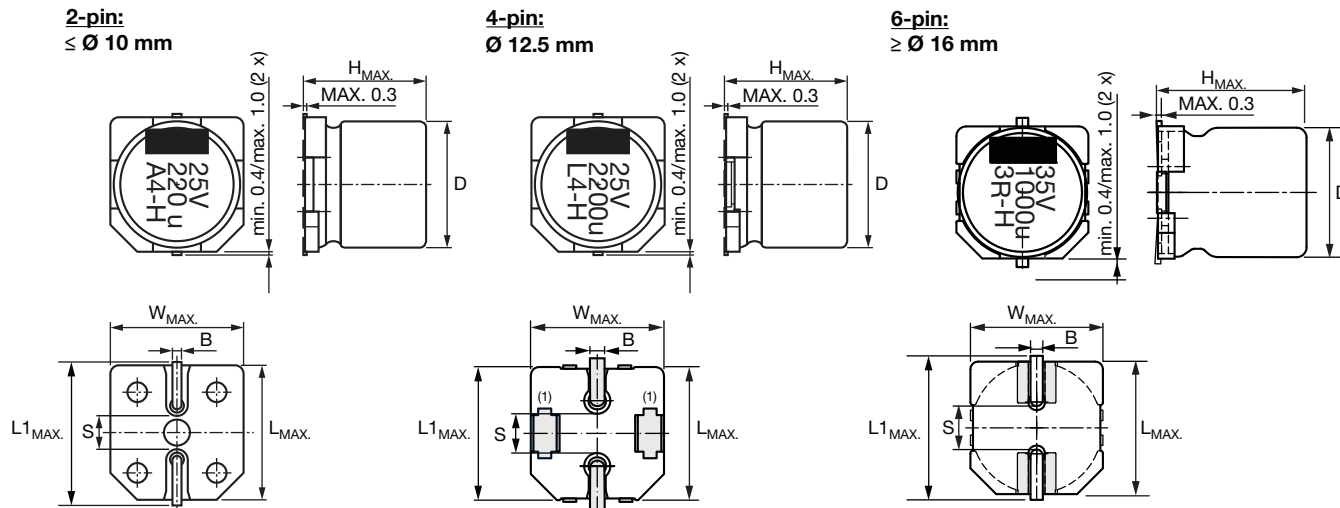


Fig. 2 - Dimensional outline

**Note**

(1) Additional dummy pins for mechanical stability, no electrical connection to pins or can

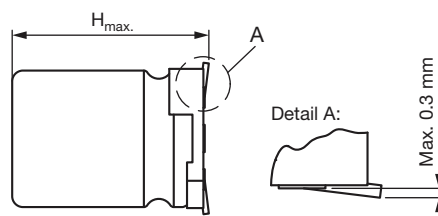


Fig. 3 - Coplanarity of pins

**Table 1**

<b>DIMENSIONS in millimeters AND MASS</b>									
NOMINAL CASE SIZE L x W x H	CASE CODE	L <sub>MAX.</sub>	W <sub>MAX.</sub>	H <sub>MAX.</sub>	Ø D	B <sub>MAX.</sub>	S	L1 <sub>MAX.</sub>	MASS (g)
10 x 10 x 10	1010	10.5	10.5	10.5	10.0	1.0	3.5	12.1	≈ 1.3
12.5 x 12.5 x 13	1213	12.9	12.9	14.0	12.5	1.3	3.6	14.9	≈ 2.6
12.5 x 12.5 x 16	1216	12.9	12.9	16.5	12.5	1.3	3.6	14.9	≈ 2.8
16 x 16 x 16	1616	16.6	16.6	17.5	16.0	1.3	6.5	18.6	≈ 5.5
16 x 16 x 21	1621	16.6	16.6	22.0	16.0	1.3	6.5	18.6	≈ 6.0
18 x 18 x 16	1816	19.0	19.0	17.5	18.0	1.3	6.5	21.0	≈ 8.0
18 x 18 x 21	1821	19.0	19.0	22.0	18.0	1.3	6.5	21.0	≈ 8.3

Table 2

TAPE AND REEL DIMENSIONS in millimeters, PACKAGING QUANTITIES						
NOMINAL CASE SIZE L x W x H	CASE CODE	PITCH P <sub>1</sub>	TAPE WIDTH W	TAPE THICKNESS T <sub>2</sub>	REEL DIAMETER	PACKAGING QUANTITY PER REEL
10 x 10 x 10	1010	16	24	11.6	380	500
12.5 x 12.5 x 13	1213	20	24	16.2	380	250
12.5 x 12.5 x 16	1216	24	32	18.5	380	200
16 x 16 x 16	1616	28	44	18.9	380	150
16 x 16 x 21	1621	28	44	23.4	380	100
18 x 18 x 16	1816	32	44	18.9	380	125
18 x 18 x 21	1821	32	44	23.4	380	100

**Note**

- Detailed tape dimensions see section "PACKAGING"

**MOUNTING**

The capacitors are designed for automatic placement on to printed-circuit boards.

Optimum dimensions of soldering pads depend amongst others on soldering method, mounting accuracy, print layout and / or adjacent components.

For recommended soldering pad dimensions, refer to Fig. 4 and Table 3.

**SOLDERING**

Soldering conditions are defined by the curve, temperature versus time, where the temperature is that measured on the component during processing.

For maximum conditions refer to Fig. 5.

Any temperature versus time curve which does not exceed the specified maximum curves may be applied.

As a general principle, temperature and duration shall be the **minimum** necessary required to ensure good soldering connections. However, the specified maximum curves should never be exceeded.

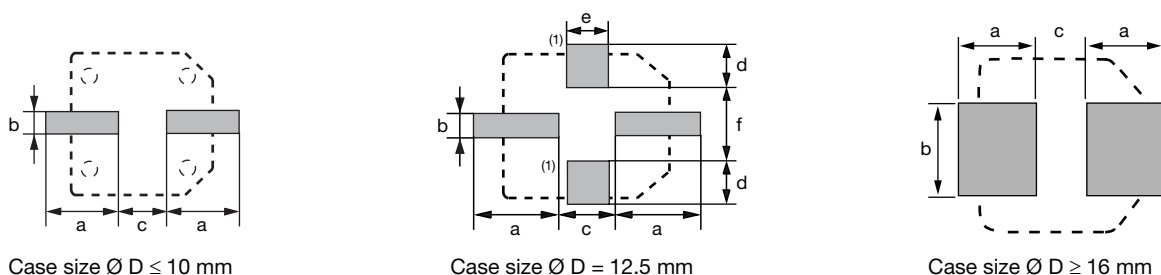


Fig. 4 - Recommended soldering pad dimensions

**Note**

- (1) Additional solder pads, can be connected to GND or open

Table 3

RECOMMENDED SOLDERING PAD DIMENSIONS in millimeters						
CASE CODE	a	b	c	d	e	f
1010	4.4	2.5	4.0	-	-	-
1213	6.3	2.5	4.0	4.2	5.0	5.6
1216	6.3	2.5	4.0	4.2	5.0	5.6
1616	7.8	9.6	4.7	-	-	-
1621	7.8	9.6	4.7	-	-	-
1816	8.8	9.6	4.7	-	-	-
1821	8.8	9.6	4.7	-	-	-

# **ADVANCED SOLDERING PROFILE FOR LEAD (Pb)-FREE REFLOW PROCESS ACCORDING TO JEDEC J-STD-020**

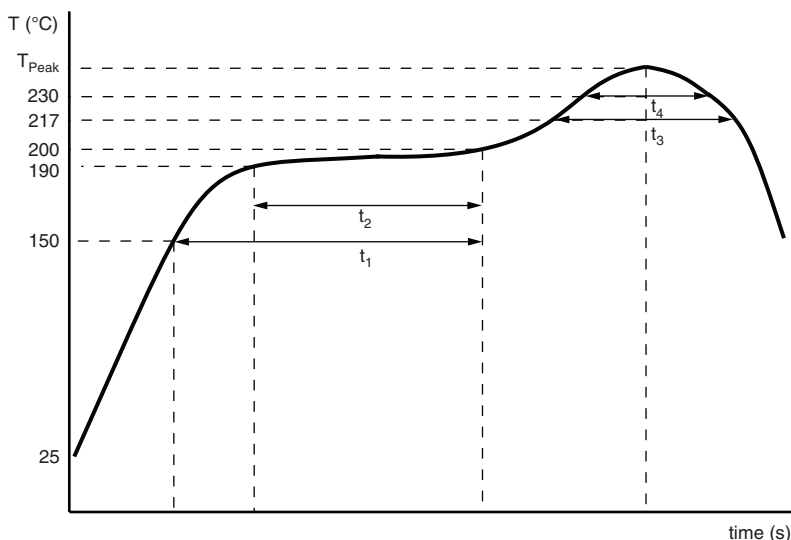


Fig. 5 - Maximum temperature load during reflow soldering

Table 4

<b>REFLOW SOLDERING CONDITIONS</b> for MAL219299xxxE3			
<b>PROFILE FEATURES</b>	<b>CASE CODE 1010</b>	<b>CASE CODE 1213 TO 1216</b>	<b>CASE CODE 1616 TO 1821</b>
Max. time from 25 °C to $T_{Peak}$	300 s	300 s	300 s
Max. ramp-up rate to 150 °C	3 K/s	3 K/s	3 K/s
Max. time from 150 °C to 200 °C ( $t_1$ )	150 s	150 s	150 s
Max. time from 190 °C to 200 °C ( $t_2$ )	110 s	110 s	110 s
Ramp up rate from 200 °C to $T_{Peak}$	0.5 K/s to 3 K/s	0.5 K/s to 3 K/s	0.5 K/s to 3 K/s
Max. time above $T_{Liquidus}$ (217 °C) ( $t_3$ )	90 s	90 s	90 s
Max. time above 230 °C ( $t_4$ )	70 s	65 s	60 s
Peak temperature $T_{Peak}$	260 °C	250 °C	245 °C
Max. time above $T_{Peak}$ minus 5 °C	40 s	30 s	30 s
Ramp-down rate from $T_{Liquidus}$	3 K/s to 6 K/s	3 K/s to 6 K/s	3 K/s to 6 K/s

## **Notes**

- Temperature measuring point on top of the case and on terminals
- Max. 2 runs with pause of min. 30 min in between

ELECTRICAL DATA	
SYMBOL	DESCRIPTION
$C_R$	Rated capacitance at 100 Hz, tolerance $\pm 20\%$
$I_R$	Rated RMS ripple current at 100 Hz, 125 °C
$I_{L1}$	Max. leakage current after 1 min at $U_R$
$\tan \delta$	Max. dissipation factor at 100 Hz
$Z$	Max. impedance at 100 kHz

**Note**

- Unless otherwise specified, all electrical values in Table 5 apply at  $T_{amb} = 20\text{ °C}$ ,  $P = 86\text{ kPa}$  to  $106\text{ kPa}$ ,  $RH = 45\%$  to  $75\%$

**Table 5**

ELECTRICAL DATA AND ORDERING INFORMATION								
$U_R$ (V)	$C_R$ ( $\mu\text{F}$ )	NOMINAL CASE SIZE L x W x H (mm)	$I_R$ 125 °C 100 Hz (mA)	$I_{L1}$ 1 min ( $\mu\text{A}$ )	$\tan \delta$ 100 Hz	$Z$ 10 kHz 20 °C ( $\Omega$ )	LIFE CODE <sup>(1)</sup>	ORDERING CODE MAL2192.....
400	2.2	10 x 10 x 10	30	96	0.20	14.5	L1	99601E3
	4.7	12.5 x 12.5 x 13	50	126	0.20	5.9	L1	99602E3
	5.6	12.5 x 12.5 x 16	65	137	0.20	5.2	L2	99603E3
	10	16 x 16 x 16	90	190	0.20	2.9	L2	99604E3
	15	16 x 16 x 21	110	250	0.20	2.1	L3	99605E3
	22	18 x 18 x 16	120	334	0.20	1.7	L2	99606E3
	33	18 x 18 x 21	160	466	0.20	1.1	L3	99607E3

**Note**

- <sup>(1)</sup> Determines the applicable row in the table “Endurance Test Duration and Useful Life”

**Table 6**

ADDITIONAL ELECTRICAL DATA		
PARAMETER	CONDITIONS	VALUE
<b>Voltage</b>		
Surge voltage for short periods	IEC 60384-18, subclause 4.14	$U_S \leq 1.10 \times U_R$
Reverse voltage for short periods	IEC 60384-18, subclause 4.16; $T_A \leq 125\text{ °C}$	$U_{rev} \leq 1\text{ V}$
<b>Current</b>		
Leakage current	After 1 min at $U_R$	$I_{L1} \leq 0.03 \times C_R \times U_R + 70\text{ }\mu\text{A}$
	After 5 min at $U_R$	$I_{L5} \leq 0.015 \times C_R \times U_R + 30\text{ }\mu\text{A}$
<b>Inductance</b>		
Equivalent series inductance (ESL)	$\varnothing D = 10\text{ mm}$	Typ. 16 nH
	$\varnothing D \geq 12.5\text{ mm}$	Typ. 18 nH
<b>Resistance</b>		
Equivalent series resistance (ESR) at 100 Hz	Calculated from $\tan \delta_{max}$ and $C_R$ (see Table 5)	$ESR = \tan \delta / 2\pi f C_R$

## RIPPLE CURRENT AND USEFUL LIFE

Table 7

ENDURANCE TEST DURATION AND USEFUL LIFE			
LIFE CODE	ENDURANCE AT 125 °C (h)	USEFUL LIFE AT 125 °C (h)	USEFUL LIFE AT 40 °C 1.8 x I <sub>R</sub> APPLIED (h)
L1	1000	1000	75 000
L2	1000	1500	150 000
L3	2000	2500	200 000

### Note

- Multiplier of useful life code: MBC242

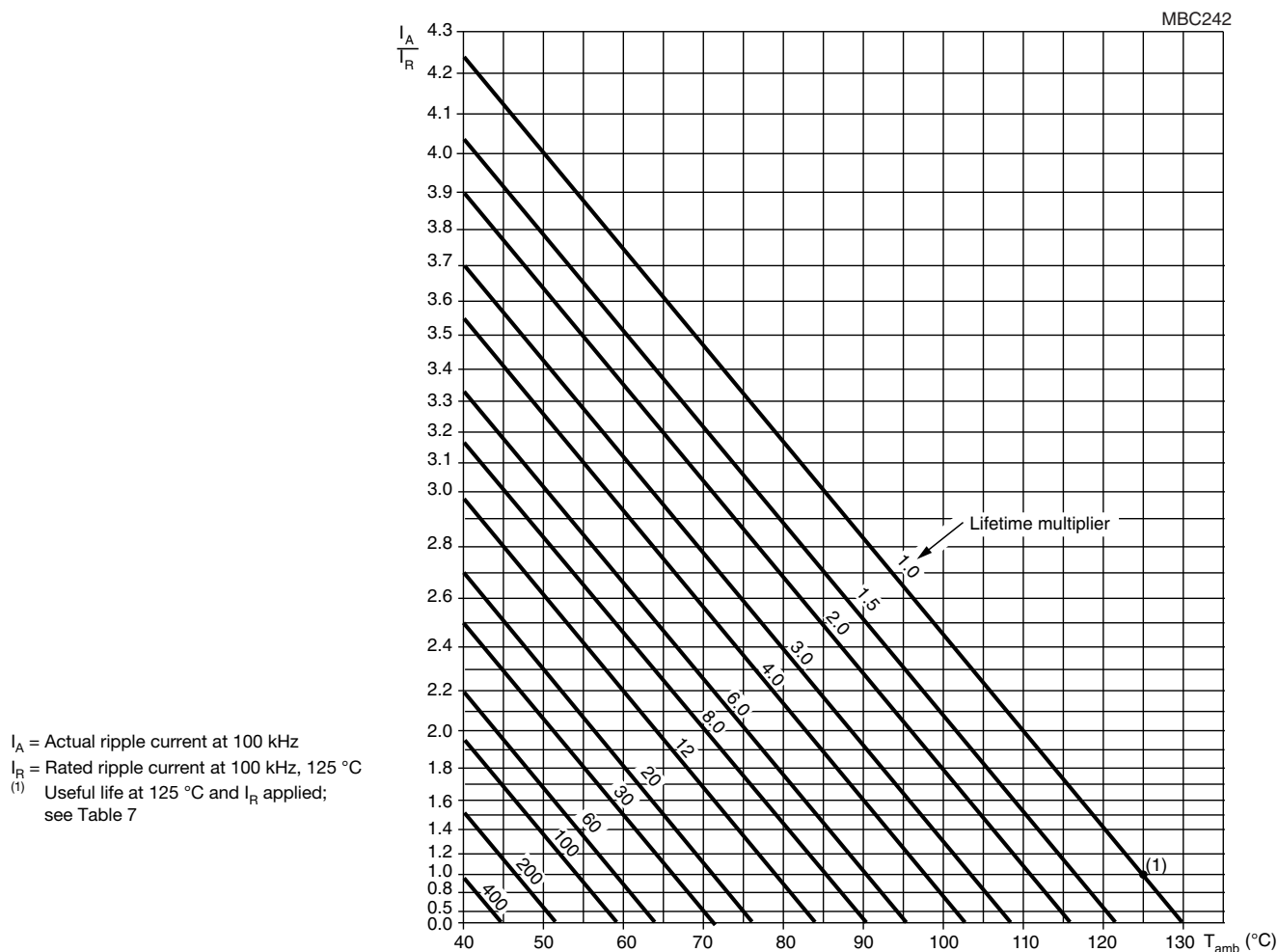


Fig. 6 - Multiplier of useful life as a function of ambient temperature and ripple current load

Table 8

MULTIPLIER OF RIPPLE CURRENT (I <sub>R</sub> ) AS A FUNCTION OF FREQUENCY							
U <sub>R</sub> (V)	FREQUENCY (Hz)						
	50	100	300	1000	3000	10 000	≥ 30 000
400	0.75	1.00	1.30	1.60	1.90	2.20	2.50

Table 9

TEST PROCEDURES AND REQUIREMENTS			
TEST		PROCEDURE (quick reference)	REQUIREMENTS
NAME OF TEST	REFERENCE		
Mounting	IEC 60384-18, subclause 4.3	Shall be performed prior to tests mentioned below; reflow soldering; for maximum temperature load refer to chapter "Mounting"	$\Delta C/C: \pm 5 \%$ $\tan \delta \leq \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$
Endurance	IEC 60384-18 / CECC 32300, subclause 4.15	$T_{\text{amb}} = 125 \text{ }^{\circ}\text{C}$ ; $U_R$ applied; for test duration see Table 7	$U_R \geq 400 \text{ V}$ ; $\Delta C/C: \pm 20 \%$ $\tan \delta \leq 2 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$
Useful life	CECC 30301, subclause 1.8.1	$T_{\text{amb}} = 125 \text{ }^{\circ}\text{C}$ ; $U_R$ and $I_R$ applied; for test duration see Table 7	$\Delta C/C: \pm 50 \%$ $\tan \delta \leq 3 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ no short or open circuit total failure percentage: $\leq 1 \%$
Shelf life (storage at high temperature)	IEC 60384-18 / CECC 32300, subclause 4.17	$T_{\text{amb}} = 125 \text{ }^{\circ}\text{C}$ ; no voltage applied; 1000 h after test: $U_R$ to be applied for 30 min, 24 h to 48 h before measurement	For requirements see "Endurance test" above
Reverse voltage	IEC 60384-18 / CECC 32300, subclause 4.16	$T_{\text{amb}} = 125 \text{ }^{\circ}\text{C}$ : 125 h at $U = -1.0 \text{ V}$ , followed by 125 h at $U_R$	$\Delta C/C: \pm 15 \%$ $\tan \delta \leq 1.5 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$

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